

## **Smart Quad Channel Powertrain Switch**





### 1 Overview

#### **Features**

- Configurable overcurrent protection
- Overtemperature protection
- Open load detection
- · Short circuit to GND detection
- Electrostatic Discharge (ESD) protection
- 16-Bit SPI (for diagnostic and control)
- Soldering: Automated Optical Inspection capability (AOI)
- Green product (completely lead free)
- AEC qualified

## **Potential applications**

The TLE9104SH is best suited for Automotive Powertrain applications. It can be used as driver IC for inductive and ohmic actuators such as injectors, solenoids and relays.

### **Product validation**

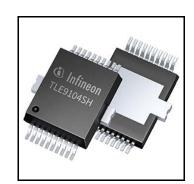
Qualified for Automotive Applications. Product Validation according to AEC-Q100/101.

## **Description**

Quad Low-Side Switch in Smart Power Technology (SPT) with four open drain DMOS output stages. The TLE9104SH is protected by embedded protection functions and designed for automotive powertrain applications. The output stages can be controlled directly by parallel inputs for PWM applications (for example gasoline multiport injection) or by SPI.

Туре	Package	Marking
TLE9104SH	PG-DSO-20-88	TLE9104SH

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## **Smart Quad Channel Powertrain Switch**



#### Overview

## Table 1 Product summary

Parameter	Symbol	Value, Unit
Signal supply voltage	V <sub>IO</sub>	3.05.5 V
Analog supply voltage	$V_{\scriptscriptstyle  extsf{DD}}$	4.55.5 V
Output clamping voltage	$V_{DS(AZ)}$	5060 V
Typical On-state resistance CH 1-4 at $T_j = 25$ °C	$R_{ extsf{DS(ON)}}$	150 mΩ
Typical On-state resistance CH 1-4 at $T_j = 150$ °C	$R_{ extsf{DS(ON)}}$	300 mΩ
Nominal load current CH 1-4 (continuous)	I <sub>D</sub>	3 A
Short circuit to battery detection threshold CH 1-4	I <sub>SCB</sub>	5 A

## **Smart Quad Channel Powertrain Switch**



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**Block diagram** 

# 2 Block diagram

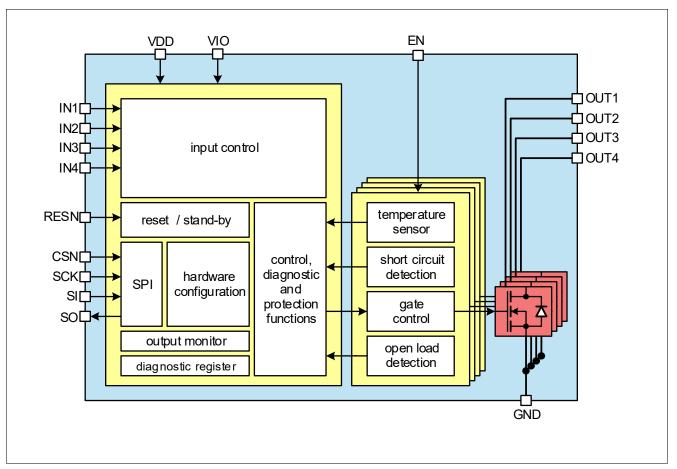


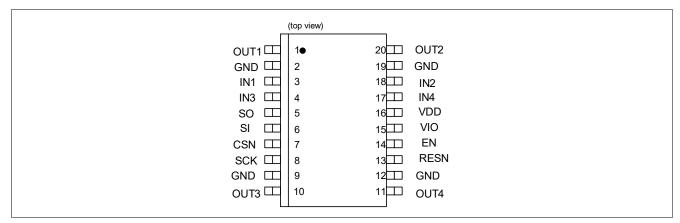
Figure 2-1 Block diagram



Pin configuration

# **3** Pin configuration

## 3.1 Pin assignment



**Figure 3-1 Pin configuration** (top view)

### 3.2 Pin definitions and functions

Table 3-1 Pin configuration

#	Pin Name	Function
1	OUT1	Power Output 1
2	GND	Ground
3	IN1	Input 1
4	IN3	Input 3
5	SO	Serial Data Output
6	SI	Serial Data Input
7	CSN	Serial Chip Select (active low)
8	SCK	Serial Clock
9	GND	Ground
10	OUT3	Power Output 3
11	OUT4	Power Output 4
12	GND	Ground
13	RESN	Reset (active low)
14	EN	Output Enable
15	VIO	Signal Supply Voltage
16	VDD	Analog Supply Voltage
17	IN4	Input 4
18	IN2	Input 2
19	GND	Ground
20	OUT2	Power Output 2

## **Smart Quad Channel Powertrain Switch**



### **Pin configuration**

#### **Notes**

- 1. The exposed pad of TLE9104SH is not connected to ground internally. It is highly recommended to connect the exposed pad to GND pins externally.
- 2. Pins 2 and 19 are the ground pins of outputs 1 and 2 and pins 9 and 12 are the ground pins of outputs 3 and 4. It is highly recommend to connect all GND pins externally.

### **Smart Quad Channel Powertrain Switch**



**General product characteristics** 

## 4 General product characteristics

## 4.1 Absolute maximum ratings

#### Table 4-1 Absolute maximum ratings

 $T_j$  = -40°C to +150°C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Valu	es	Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Signal supply voltage	V <sub>IO</sub>	-0.3	_	5.5	V	_	P_4.1.1
Analog supply voltage	$V_{\scriptscriptstyle  m DD}$	-0.3	_	5.5	V	_	P_4.1.2
Continuous drain source voltage (OUT1 to OUT4)	$V_{ extsf{DS}}$	-0.3	-	50	V	-	P_4.1.3
Input voltage, all inputs and data outputs, sense lines	V <sub>IN</sub>	-0.3	-	V <sub>IO</sub> + 0.3	V	-	P_4.1.4
Output current per channel <sup>1)</sup>	I <sub>D</sub>	0	_	5.6	Α	Output ON	P_4.1.5
Maximum voltage for short circuit protection (single event) <sup>2)</sup>	$V_{\rm SC,single}$	_	-	30	V	-	P_4.1.6
Electrostatic Discharge voltage - HBM (human body model) <sup>3)</sup>	$V_{ESD1}$	-2000	-	2000	V	-	P_4.1.7
<b>E</b> lectro <b>s</b> tatic <b>D</b> ischarge voltage - CDM (charge device model) <sup>4)</sup>	$V_{ESD2}$	-500	-	500	V	-	P_4.1.8

<sup>1)</sup> Output current rating as long as maximum junction temperature is not exceeded. The maximum output current in the application must be calculated using  $R_{\rm thJA}$  depending on mounting conditions.

- 2) Short circuit is designed to be short circuit robust according to AEC-Q100-012.
- 3) According to ANSI/ESDA/JEDEC JS-001.
- 4) According to JESD22-C101.

#### **Notes**

- 1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the datasheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

### **Smart Quad Channel Powertrain Switch**



### **General product characteristics**

## 4.2 Operating conditions

**Table 4-2 Operating conditions** 

Parameter	Symbol		Value	5	Unit	Note or Test Condition	Number
		Min.	Тур.	Max.			
Maximum output clamping energy, linearly decreasing current 1) 2)	<b>E</b> <sub>AR</sub>	14	-	-	mJ	I <sub>D(0)</sub> = 1.4 A, T <sub>J(0)</sub> = 110°C, Cycles: 1 billion	P_4.2.6
Maximum output clamping energy, linearly decreasing current <sup>3)</sup>	<b>E</b> <sub>AS</sub>	35	-	-	mJ	<i>T</i> <sub>J</sub> = 85°C, Cycles: 10	P_4.2.13
Maximum output clamping energy, linearly decreasing current	<b>E</b> <sub>AS</sub>	25	-	-	mJ	<i>T</i> <sub>J</sub> = 145°C, Cycles: 10	P_4.2.14
Maximum output clamping energy in parallel mode	E <sub>AR,p</sub>	1.7 × <i>E</i> <sub>AR</sub>	-	-	mJ	OUT1&2 or OUT3&4, $I_{D(0), P} = 1.8 \times I_{D(0)}$	P_4.2.2
Thermal resistance							1
Junction to case	$R_{thJC}$	_	1	1.25	K/W	PV = 3 W, homogenously distributed between all output stages	P_4.2.3
Temperature range							1
Operating temperature range	T <sub>i</sub>	-40	_	150	°C	-	P_4.2.4
Storage temperature range	$T_{\rm stg}$	-55	-	150	°C	_	P_4.2.5

- 1) Pulse shape represents inductive switch off:  $I_D(t) = I_D(0) \times (1 t / t_{pulse})$ ;  $0 < t < t_{pulse}$
- 2) The given energy values are based on a cumulative scenario as specified in the Notes column.
- 3) The given energy values are based on a cumulative scenario as specified in the Notes column.

Note: Within the functional range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given by the related electrical characteristics table.

## **Smart Quad Channel Powertrain Switch**



**Electrical and functional description of blocks** 

## 5 Electrical and functional description of blocks

### 5.1 Power supply

The TLE9104SH is supplied by analog power supply line  $V_{\rm DD}$  and signal power supply  $V_{\rm IO}$ . A capacitor between pins  $V_{\rm DD}$  to GND and  $V_{\rm IO}$  to GND is recommended. After start-up of the power supply, the RESN pin should be kept low until the Reset Duration Time has expired. This will reset all SPI registers to their default values. In order to enable the output stages the EN pin has to be kept high and OUT\_EN register has to be set.

Table 5-1 Electrical characteristics: power supply

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, (unless otherwise specified) all voltages with respect to ground, positive current flowing into pin

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Signal supply voltage	V <sub>IO</sub>	3	_	5.5	٧	_	P_5.1.1
Analog supply voltage	$V_{\scriptscriptstyle  m DD}$	4.5	_	5.5	V	_	P_5.1.2
Supply current	I <sub>DD(on)</sub>	_	_	10	mA	_	P_5.1.3
Input low voltage of pin RESN	$V_{RESN(L)}$	-0.3	_	1	V	_	P_5.1.4
Input high voltage of pin RESN	$V_{\text{RESN(H)}}$	2	_	V <sub>IO</sub> + 0.3	٧	_	P_5.1.5
Hysteresis voltage of pin RESN	V <sub>RESN(Hys)</sub>	100	300	500	mV	_	P_5.1.6
Input pull-up current through pin RESN	I <sub>RESN</sub>	-100	-65	-30	μΑ	V <sub>RESET</sub> = 0 V	P_5.1.7
Reset duration time <sup>1)</sup>	t <sub>RESN(L)</sub>	10	_	_	μs	_	P_5.1.8
Input low voltage of pin EN	$V_{\rm EN(L)}$	-0.3	_	1	V	_	P_5.1.9
Input high voltage of pin EN	$V_{\rm EN(H)}$	2	_	$V_{10} + 0.3$	٧	_	P_5.1.10
Hysteresis voltage of pin EN	$V_{\rm EN(Hys)}$	100	300	500	mV	_	P_5.1.11
Input pull-down current through pin EN	<b>I</b> <sub>EN</sub>	30	65	100	μΑ	V <sub>EN</sub> = 2 V	P_5.1.12

<sup>1)</sup> For proper startup, after the supply  $V_{\rm DD}$  has reached its final voltage, the RESN pin should be held low until the reset duration time has expired.

## **Smart Quad Channel Powertrain Switch**



#### **Electrical and functional description of blocks**

### 5.2 Parallel inputs

Each input signal controls the output stage of its related channel. For example, IN1 controls OUT1, IN2 controls OUT2 etc. Input signals are active low. Hence, applying a voltage less than  $V_{\text{IN(L)}}$  to INx turns OUTx on. It is possible to connect OUT1-2 and OUT3-4 in parallel. For this purpose the right configuration has to be selected in the CFG register. In this case IN1 controls OUT1-2 and IN3 controls OUT3-4.

#### Table 5-2 Electrical characteristics: parallel inputs

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, (unless otherwise specified) all voltages with respect to ground, positive current flowing into pin (unless for pin SO)

Parameter	Symbol		Values			Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Input low voltage of pin INx	$V_{IN(L)}$	-0.3	_	1	V	-	P_5.2.1
Input high voltage of pin INx	V <sub>IN(H)</sub>	2	-	V <sub>IO</sub> + 0.3	V	_	P_5.2.2
Input voltage hysteresis	$V_{\text{IN(Hys)}}$	100	300	500	mV	-	P_5.2.3
Input pull-up current through pin INx	I <sub>IN(L)</sub>	-100	-65	-30	μΑ	<i>V</i> <sub>IN</sub> = 0 V	P_5.2.4

#### 5.3 Power stages

#### Table 5-3 Electrical characteristics: power outputs

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, (unless otherwise specified) all voltages with respect to ground, positive current flowing into pin (unless for pin SO)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
ON resistance	$R_{ extsf{DS(ON)}}$	-	150		mΩ	$T_{\rm J} = 25^{\circ}{\rm C},$	P_5.3.1
ON resistance	$R_{\rm DS(ON)}$	-	300	350	mΩ	$T_{\rm J} = 150^{\circ}{\rm C}$ ,	P_5.3.2
ON resistance in parallel mode	R <sub>DS(ON)</sub>	_	75	-	mΩ	$T_J$ = 25°C, outputs 1&2 or 3&4 in parallel	P_5.3.3
ON resistance in parallel mode	R <sub>DS(ON)</sub>	-	150	175	mΩ	$T_J$ = 150°C, outputs 1&2 or 3&4 in parallel	P_5.3.4
Output clamping voltage	$V_{\rm DS(AZ)}$	50	_	60	٧	output OFF	P_5.3.5
Output leakage current	I <sub>D(lkg)</sub>	_	_	10	μΑ	RESN=0	P_5.3.6
Output off-state current	I <sub>OUTx_OFF</sub>	_	_	30	μΑ	RESN=1, OUTx_DIAG_EN =0, V <sub>OUTx</sub> = 35 V	P_5.3.6
Turn-on time	t <sub>on</sub>	_	15	-	μs	from 50% of INx to 20% of Vbat	P_5.3.7

### **Smart Quad Channel Powertrain Switch**



### **Electrical and functional description of blocks**

### **Table 5-3 Electrical characteristics: power outputs** (cont'd)

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, (unless otherwise specified) all voltages with respect to ground, positive current flowing into pin (unless for pin SO)

Parameter	Symbol		Value	<b>Values</b>		Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Turn-off time	t <sub>OFF</sub>	_	15	_	μs	from 50% of INx to 80% of Vbat	P_5.3.8
Overtemperature shutdown threshold	$T_{\rm j(OT)}$	165	_	200	°C	-	P_5.3.9

#### **Smart Quad Channel Powertrain Switch**



#### **Electrical and functional description of blocks**

#### 5.4 Protection functions

The TLE9104SH provides embedded protection functions. Integrated protection functions are designed to prevent IC destruction under fault conditions. Fault conditions are considered "outside" the normal operating range. Protection functions are not designed for continuous repetitive operation. Following protection functions are implemented for TLE9104SH:

- Overtemperature protection (OT).
- Short circuit to battery protection (SCB).
- Overcurrent protection (OC).

Note: Integrated protection functions are designed to prevent IC destruction under fault conditions described in the datasheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

### 5.4.1 Overtemperature protection

A dedicated temperature sensor for each channel detects if the temperature of its channel exceeds the overtemperature shutdown threshold. If the channel temperature exceeds the overtemperature shutdown threshold, the overheated channel is switched off immediately to prevent destruction. The channel can be turned on again after clearing the overtemperature error; however, if the sensed temperature is still higher than the overtemperature shutdown threshold the channel will switch off after the filter time  $t_{\rm OT}$ .

### 5.4.2 Short circuit to battery protection

The TLE9104SH is protected in case of short circuit to battery. If the current of an output channel exceeds  $I_{SCB}$ , the respective channel is switched off immediately. The channel can be turned on again after the fault condition has been removed and the error has been cleared.

#### 5.4.3 Overcurrent protections

The TLE9104SH is protected with configurable overcurrent protection. If the current of an output channel exceeds  $I_{\rm OC}$ , the respective channel is switched off after the filter time  $t_{\rm d(OC)}$ . The channel can be turned on again after the fault condition has been removed and the error has been cleared. Both current limit threshold  $I_{\rm OC}$  and its filter time  $t_{\rm d(OC)}$  are configurable via SPI. The filter time,  $t_{\rm d(OC)}$ , and the current limit threshold,  $I_{\rm OC}$ , can only be configured while the output bit, OUT\_EN, is low in the SPI register.

## 5.5 Diagnostic functions

Following diagnosis functions are implemented for all output stages of TLE9104SH:

- Short to battery detection (SCB) can be detected if stages are turned on.
- Overtemperature detection (OT) can be detected if stages are turned on.
- Time based overcurrent detection (OCF) can be detected if stages are turned on.
- Temperature based overcurrent detection (OCT) can be detected if stages are turned on.
- Short to GND detection (SCG) can be detected if stages are turned off.
- Open load detection (OL) can be detected if stages are turned off.

The diagnosis information of TLE9104SH can be accessed via SPI interface. OL and SCG diagnosis are recognized using two thresholds ( $V_{\text{OUTn-SCG}}$  and  $V_{\text{OUTn-OL}}$ ). It is also possible to turn off the internal diagnostic pull-down and pull-up current sources. In this case diagnosis of OL and SCG are deactivated.



### **Electrical and functional description of blocks**

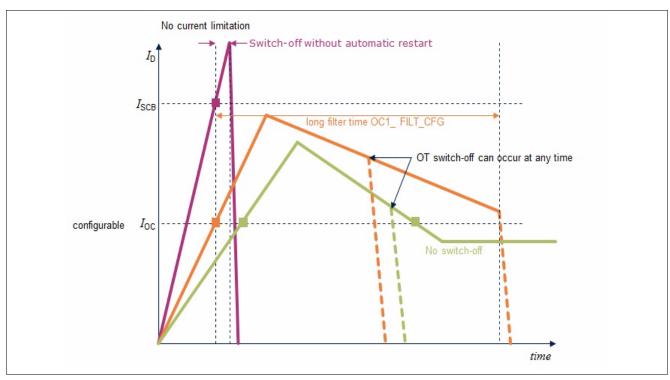


Figure 5-1 Overcurrent and short circuit to battery protection

The fault conditions SCG and OL will not be stored until an integrated filtering time,  $t_{\rm d(fault)}$ , has expired. An additional blanking time,  $t_{\rm b(fault)}$ , can be configured in addition to the filter time. The blanking time,  $t_{\rm b(fault)}$ , can only be configured while output enable bit, OUT\_EN, is low in the SPI register.

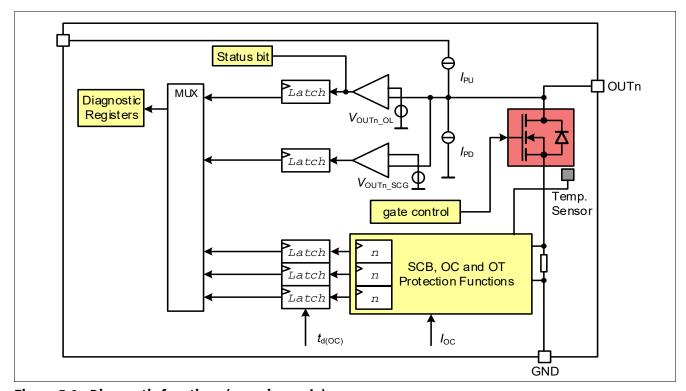


Figure 5-2 Diagnostic functions (overview only)

### **Smart Quad Channel Powertrain Switch**



### **Electrical and functional description of blocks**

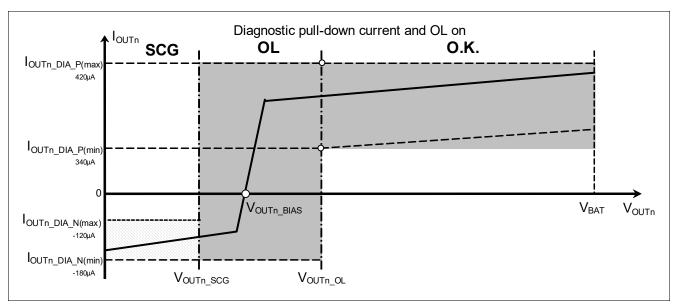


Figure 5-3 SCG and OL diagnostic function (overview only)

### Table 5-4 Electrical characteristics: diagnostic functions

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, (unless otherwise specified) all voltages with respect to ground, positive current flowing into pin (unless for pin SO)

Parameter	Symbol	mbol Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Open load detection voltage	$V_{OUTn ext{-}OL}$	0.6 V <sub>DD</sub> - 0.2	-	0.6 V <sub>DD</sub> + 0.2	V	-	P_5.5.1
Diagnostic pull-down current	$I_{PD}$	300	380	450	μΑ	$V_{\text{OUTn}} = 0.6 V_{\text{DD}}$	P_5.5.2
Diagnostic pull-up current	I <sub>PU</sub>	-180	-150	-120	μΑ	$V_{\text{OUTn}} = 0.4 V_{\text{DD}}$	P_5.5.3
Short circuit to ground detection voltage	$V_{OUTn\text{-SCG}}$	0.4 V <sub>DD</sub> - 0.2	_	0.4 <i>V</i> <sub>DD</sub> + 0.2	V	_	P_5.5.4
Short circuit to battery detection current	I <sub>SCB</sub>	4.5	5	5.6	А	_	P_5.5.5
Short circuit to battery detection current in parallel mode	I <sub>SCB</sub>	9	10	11	Α	Outputs 1&2 or outputs 3&4 connected in parallel	P_5.5.6
Fault filtering time <sup>1)</sup>	t <sub>d(fault)</sub>	0.015	0.02	0.025	ms		P_5.5.7
Fault blanking time <sup>2)</sup>	t <sub>b(fault)</sub>	0.16	0.2	0.24	ms	configurable via SPI	P_5.5.8
Fault blanking time	t <sub>b(fault)</sub>	0.4	0.5	0.60	ms	default value	P_5.5.9
Fault blanking time	t <sub>b(fault)</sub>	0.8	1	1.2	ms	configurable via SPI	P_5.5.10
Fault blanking time	t <sub>b(fault)</sub>	1.6	2	2.4	ms	configurable via SPI	P_5.5.11
Overcurrent filtering time	$t_{\rm d(OC)}$	0.04	0.06	0.08	ms	default value	P_5.5.12
Overcurrent filtering time	$t_{\rm d(OC)}$	0.1	0.12	0.14	ms	configurable via SPI	P_5.5.13
Overcurrent filtering time	$t_{ m d(OC)}$	0.4	0.5	0.6	ms	configurable via SPI	P_5.5.14

### **Smart Quad Channel Powertrain Switch**



#### **Electrical and functional description of blocks**

#### Table 5-4 Electrical characteristics: diagnostic functions (cont'd)

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, (unless otherwise specified) all voltages with respect to ground, positive current flowing into pin (unless for pin SO)

Parameter	Symbol		Value	s	Unit	t Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Overcurrent filtering time	$t_{d(OC)}$	0.8	1	1.2	ms	configurable via SPI	P_5.5.15
Overcurrent filtering time	$t_{d(OC)}$	4	5	6	ms	configurable via SPI	P_5.5.16
Overcurrent filtering time	$t_{\sf d(OC)}$	8	10	12	ms	configurable via SPI	P_5.5.17
Overcurrent filtering time	$t_{\rm d(OC)}$	16	20	24	ms	configurable via SPI	P_5.5.18
Overcurrent filtering time	$t_{\rm d(OC)}$	24	30	36	ms	configurable via SPI	P_5.5.19
Overcurrent threshold	I <sub>oc</sub>	0.75	1	1.25	Α	configurable via SPI	P_5.5.20
Overcurrent threshold	I <sub>oc</sub>	1.75	2	2.25	Α	default value	P_5.5.21
Overcurrent threshold	I <sub>oc</sub>	2.5	3	3.5	Α	configurable via SPI	P_5.5.22
Overcurrent threshold	I <sub>oc</sub>	3.5	4	4.5	Α	configurable via SPI	P_5.5.23
Overcurrent threshold in parallel mode	I <sub>oc</sub>	1.35	2	2.5	A	configurable via SPI, outputs 1&2 or outputs 3&4 connected in parallel	P_5.5.24
Overcurrent threshold in parallel mode	I <sub>oc</sub>	3.15	4	4.5	A	default value, outputs 1&2 or outputs 3&4 connected in parallel	P_5.5.25
Overcurrent threshold in parallel mode	I <sub>oc</sub>	4.5	6	7	A	configurable via SPI, outputs 1&2 or outputs 3&4 connected in parallel	P_5.5.26
Overcurrent threshold in parallel mode	I <sub>oc</sub>	6.3	8	9	A	configurable via SPI, outputs 1&2 or outputs 3&4 connected in parallel	P_5.5.27
Overtemperature filter time	t <sub>OT</sub>	2	3	4	μs	_	P_5.5.28
Short circuit to battery filter time	t <sub>SCB</sub>	1.2	-	2	μs	-	P_5.5.28

<sup>1)</sup>  $t_{\rm d(fault)}$  is the filter time for open load and short to ground diagnostic functions.

### 5.5.1 Output stage status

The output of open-load comparator of each channel is directly available via OUTx\_STAT bit. This bit can be used to detect a failure condition in which the channel is turned on by INx or SPI but the power stage remains switched off. The delay between a turn on via INx or SPI and a change in status bit depends on the output voltage slew rates and hence on the load itself.

<sup>2)</sup>  $t_{d(fault)}$  is the blanking time for open load and short to ground diagnostic functions.

### **Smart Quad Channel Powertrain Switch**



#### **Electrical and functional description of blocks**

### 5.6 Communication watchdog

The TLE9104SH is using the watchdog principle to monitor the SPI communication. In case of no communication or continuous communication failures all outputs are disabled. In case of a faulty SPI frame the CWD timer does not retrigger and after the filter time the register CWD-TO is set and can be read as soon as the SPI is back to normal operation. The watchdog is active by default; however, it can be deactivated via a SPI command.

The watchdog starts to work as soon as the device has finished start-up and all blocks are released from reset. If these conditions are met, the watchdog timer  $t_{\text{CWD}}$  is started. Each correct SPI communication restarts the  $t_{\text{CWD}}$  timer. If no valid communication is received within timeout, the  $t_{\text{CWD}}$  timer will expire and disable all outputs. For re-enabling, one needs to clear the error and enable outputs via SPI. Outputs will not be enabled automatically by clearing the error.

The watchdog timer  $t_{CWD}$  is configurable via SPI. The watchdog timer  $t_{CWD}$  can only be configured while the output enable bit, OUT\_EN, is low in the SPI register.

Following SPI communication issues are detected as failure by the watchdog:

- · No communication
- Wrong commands
- · Frames not equal to 16 clocks

### Table 5-5 Communication watchdog timeout configuration

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, (unless otherwise specified) all voltages with respect to ground, positive current flowing into pin (unless for pin SO)

Parameter	Symbol	Values		/alues		Values		Note or	Number
		Min.	Тур.	Max.		Test Condition			
Communication watchdog timeout	$t_{\text{CWD0}}$	20	25	30	ms	configurable via SPI	P_5.6.1		
Communication watchdog timeout	$t_{\text{CWD1}}$	40	50	60	ms	default value	P_5.6.2		
Communication watchdog timeout	t <sub>CWD2</sub>	60	75	90	ms	configurable via SPI	P_5.6.3		



16 bit SPI interface

#### 6 16 bit SPI interface

The diagnostic and control interface is based on a serial peripheral interface (SPI).

The SPI is a full duplex synchronous serial slave interface, which uses four lines: SO, SI, SCK, CSN. Data is transferred by the lines SI and SO at the data rate given by SCK. The falling edge of CSN indicated the beginning of a data access. Data is sampled in on line SI at the falling edge of SCK and shifted out on line SO at the rising edge of SCK. Each access shall be terminated by a rising edge of CSN. A modulo 16 counter ensures that data is taken only, when a multiple of 16 bits has been transferred.

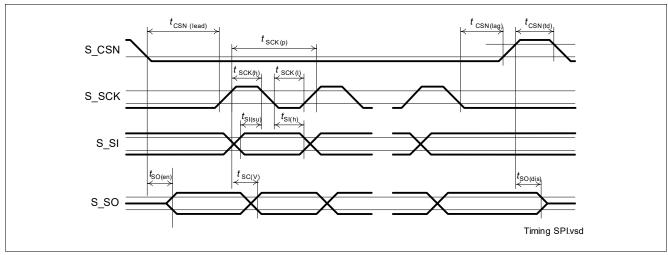


Figure 6-1 SPI timing

#### 6.1 Electrical characteristics 16 bit SPI interface

### Table 6-1 Electrical characteristics: 16 bit SPI interface

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	mbol		s	Unit	Note or	Number	
		Min.	Тур.	Max.		<b>Test Condition</b>		
Input characteristics (CSN, SCK	, SI)							
L level of pin CSN, SCK, SI	$V_{\text{IO\_CSNL}}$ $V_{\text{IO\_SCKL}}$ $V_{\text{IO\_SIL}}$	-0.3	_	1	V	-	P_6.1.1	
H level of pin CSN, SCK, SI	$V_{\text{IO\_CSNH}}$ $V_{\text{IO\_SCKH}}$ $V_{\text{IO\_SIH}}$	2	_	V <sub>IO</sub> + 0.3	V	_	P_6.1.2	
Hysteresis input pins	$V_{\text{IO\_CSNHy}} \ V_{\text{IO\_SCKHy}} \ V_{\text{IO\_SIHy}}$	100	300	500	mV	_	P_6.1.3	
Output characteristics (SO)								
L level output voltage	$V_{\text{IO\_SOL}}$	0	-	1	V	$I_{IO_SO} = -2 \text{ mA}$	P_6.1.4	
H level output voltage	$V_{\text{IO\_SOH}}$	V <sub>IO</sub> - 0.5	-	V <sub>IO</sub> + 0.3	_	_	P_6.1.5	
Output tristate leakage current	I <sub>IO_SOoff</sub>	-10	-	10	μΑ	_	P_6.1.6	

## **Smart Quad Channel Powertrain Switch**



#### 16 bit SPI interface

#### Table 6-1 Electrical characteristics: 16 bit SPI interface

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $V_{\rm IO}$  = 3 V to 5.5 V,  $T_{\rm j}$  = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Value	s	Unit	Note or	Number	
		Min.	Тур.	Max.		<b>Test Condition</b>		
Input capacitance		<u> </u>		*	<u>'</u>		•	
For CSN, SCK, SI and SO	C <sub>in</sub>	-	6	8	pF	_	P_6.1.13	
Timings								
Serial clock frequency <sup>1)</sup>	<b>f</b> <sub>SCK</sub>	0	_	8	MHz	C <sub>L</sub> = 25 pF	P_6.1.7	
Serial clock period	t <sub>SCK(P)</sub>	125	-	_	ns	_	P_6.1.8	
Serial clock high time	t <sub>SCK(h)</sub>	50	-	_	ns	_	P_6.1.9	
Serial clock low time	$t_{SCK(I)}$	50	_	_	ns	_	P_6.1.10	
Enable lead time (falling CSN to rising SCK)	t <sub>CSN(lead)</sub>	250	_	-	ns	-	P_6.1.11	
Enable lag time (falling SCK to rising CSN)	t <sub>CSN(lag)</sub>	250	-	-	ns	-	P_6.1.12	
Data setup time (required time SI to falling SCK)	t <sub>SI(su)</sub>	20	-	-	ns	-	P_6.1.14	
Data hold time (falling SCK to SI)	t <sub>SI(h)</sub>	20	-	_	ns		P_6.1.15	
Output enable time (falling CSN to SO valid)	t <sub>SO(en)</sub>	-	-	200	ns	<i>C</i> <sub>L</sub> = 25 pF	P_6.1.16	
Output disable time (rising CSN to SO tri-state)	t <sub>SO(dis)</sub>	-	-	200	ns	<i>C</i> <sub>L</sub> = 25 pF	P_6.1.17	
Output data valid time with capacitive load	t <sub>SO(v)</sub>	-	-	100	ns	C <sub>L</sub> = 25 pF	P_6.1.18	
Transfer delay time (rising CSN to falling CSN)	t <sub>CSN(td)</sub>	1	-	100	μs	C <sub>L</sub> = 25 pF	P_6.1.19	

<sup>1)</sup> Maximum SPI clock frequency in the application may be less depending on the load at the SO pin and the microcontroller SPI peripheral timing requirements.

#### **Smart Quad Channel Powertrain Switch**



#### 16 bit SPI interface

### 6.2 SPI registers

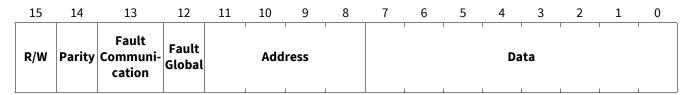
The general SPI frame length is fixed at 16 bits. Bits 0 to 7 of each frame are used as data frame, bits 8 to 10 are used for address, bit 14 is the parity bit and bit 15 is used to specify a command as read or write. The parity bit is defined as:

$$b_{14} = (1 + b_{15} + \sum_{i=0}^{13} b_i) \mod 2$$
 (6.1)

#### **MOSI**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R/W	Parity	0	0		Add	ress					Da	ta			

#### **MISO**



IN MOSI and MISO a read is defined with a '0' and a write is defined with a '1'. Each MISO SPI frame reports the important system faults as Global or Communication faults in bit 12 and 13 as following:

- Global fault is asserted (not latching) when the general fault bit in Global\_Status register is set.
- Communication fault is asserted (not latching) when one of the following faults are present:
  - Communication error (the same as COM\_ERR in Global\_Status register)
  - Communication watchdog timeout
  - Parity error

Besides, global status register stores the faults as following:

- General fault if at least one of the following faults are present:
  - Over-current
  - Over-temperature
  - Over-temperature during overcurrent
  - Short circuit to battery
  - Open load
  - Short circuit to ground
- Communication error:
  - No communication
  - Wrong command
  - Frames not equal to 16 bits
- · Parity error
- · Communication watchdog

### **Smart Quad Channel Powertrain Switch**



#### 16 bit SPI interface

Apart from the faults, global register also restores the enable latch signal (EN\_Latch) and power on reset latch (POR\_Latch) as following:

- EN\_Latch: This bit has a reset value of '0'. After setting the OUT\_EN bit this bit changes to '1'. This bit shows whether the output has been enabled (via SPI) at least once since the last clear.
- POR\_Latch: This bit has a reset value of '1'. It can be changed to '0' via SPI. Any power on reset will set the bit back to 1. This can be used to check whether a power on reset has happened since the bit value was changed to '0'.

## **Smart Quad Channel Powertrain Switch**



#### 16 bit SPI interface

Table 6-2 Register Address Space

Module	Base Address	End Address	Note
apb	0 <sub>H</sub>	1F <sub>H</sub>	_

Table 6-3 Register Overview

Register Short Name	Register Long Name	Offset Address	Page Number
CTRL	Output control register	00 <sub>H</sub>	22
CFG	Configuration register	01 <sub>H</sub>	24
OFF_DIAG_CFG	Off-state diagnostic configuration register	02 <sub>H</sub>	25
ON_DIAG_CFG	On-state diagnostic configuration register	03 <sub>H</sub>	26
DIAG_OUT_1_2_ON	On-state diagnostic result register OUT1 & OUT2	04 <sub>H</sub>	27
DIAG_OUT_3_4_ON	On-state diagnostic result register OUT3 & OUT4	05 <sub>H</sub>	28
DIAG_OFF	Off-state diagnostic result register	06 <sub>H</sub>	29
GLOBAL_STATUS	Global device status register	07 <sub>H</sub>	30
IC Version ID		08 <sub>H</sub>	31

The registers are addressed wordwise.

Table 6-4 Register Overview

Bit type short name	Bit type description	Note
r	read	-
rw	read/write	-
rwc	read and clear on write	clear on write 0

Note: All configurations can only be changed while the OUT\_EN bit is cleared.

## **Smart Quad Channel Powertrain Switch**



16 bit SPI interface

# 6.2.1 Registers

**Output control register** 

CTRL	Offset	Reset Value
Output control register	00 <sub>H</sub>	00 <sub>H</sub>

	7	6	5	4	3	2	1	0
	OUT4_ON	OUT4_ON	OUT3_ON	OUT3_ON	OUT2_ON	OUT2_ON	OUT1_ON	OUT1_ON
	_S	_C	_S	_C	_S	_C	_S	_C
,	rw							

Field	Bits	Туре	Description
OUT4_ON_S	7	rw	OUT4 SPI control bit (used if CFG.OUT4_DD = 0)  1 <sub>D</sub> SET, Output 4 set  0 <sub>D</sub> NO_ACTION, Output 4 no action  Reset: 0 <sub>B</sub>
OUT4_ON_C	6	rw	OUT4 SPI control bit (used if CFG.OUT4_DD = 0)  1 <sub>D</sub> CLEAR, Output 4 clear  0 <sub>D</sub> NO_ACTION, Output 4 no action  Reset: 0 <sub>B</sub>
OUT3_ON_S	5	rw	OUT3 SPI control bit (used if CFG.OUT3_DD = 0)  1 <sub>D</sub> SET, Output 3 set  0 <sub>D</sub> NO_ACTION, Output 3 no action  Reset: 0 <sub>B</sub>
OUT3_ON_C	4	rw	OUT3 SPI control bit (used if CFG.OUT3_DD = 0)  1 <sub>D</sub> CLEAR, Output 3 clear  0 <sub>D</sub> NO_ACTION, Output 3 no action  Reset: 0 <sub>B</sub>
OUT2_ON_S	3	rw	OUT2 SPI control bit (used if CFG.OUT2_DD = 0)  1 <sub>D</sub> SET, Output 2 set  0 <sub>D</sub> NO_ACTION, Output 2 no action  Reset: 0 <sub>B</sub>
OUT2_ON_C	2	rw	OUT2 SPI control bit (used if CFG.OUT2_DD = 0)  1 <sub>D</sub> CLEAR, Output 2 clear  0 <sub>D</sub> NO_ACTION, Output 2 no action  Reset: 0 <sub>B</sub>
OUT1_ON_S	1	rw	OUT1 SPI control bit (used if CFG.OUT1_DD = 0)  1 <sub>D</sub> SET, Output 1 set  0 <sub>D</sub> NO_ACTION, Output 1 no action  Reset: 0 <sub>B</sub>

## **Smart Quad Channel Powertrain Switch**



### 16 bit SPI interface

Field	Bits	Туре	Description
OUT1_ON_C	0	rw	OUT1 SPI control bit (used if CFG.OUT1_DD = 0)
			1 <sub>D</sub> CLEAR, Output 1 clear
			0 <sub>D</sub> <b>NO_ACTION</b> , Output 1 no action
			Reset: 0 <sub>B</sub>

## **Smart Quad Channel Powertrain Switch**



### 16 bit SPI interface

## **Configuration register**

CFG	Offset	Reset Value	
Configuration register	01 <sub>H</sub>	8F <sub>H</sub>	

7 6	5	4	3	2	1	0
CWD_TIME	OUT3_4_ PAR	OUT1_2_ PAR	OUT4_DD	OUT3_DD	OUT2_DD	OUT1_DD

Field	Bits	Type	Description
CWD_TIME	7:6	rw	Communication watchdog timeout configuration  3 <sub>D</sub> LONG, 75 ms  2 <sub>D</sub> MEDIUM, 50 ms (default)  1 <sub>D</sub> SHORT, 25 ms  0 <sub>D</sub> DISABLED, Communication watchdog disabled  Reset: 10 <sub>B</sub>
OUT3_4_PAR	5	rw	OUT3-4 parallel mode  1 <sub>D</sub> ENABLED, OUT3-4 parallel mode (controlled by IN3 or CTRL.OUT3_ON)  0 <sub>D</sub> DISABLED, OUT3, OUT4 controlled separately (default)  Reset: 0 <sub>B</sub>
OUT1_2_PAR	4	rw	OUT1-2 parallel mode  1 <sub>D</sub> ENABLED, OUT1-2 parallel mode (controlled by IN1 or CTRL.OUT1_ON)  0 <sub>D</sub> DISABLED, OUT1, OUT2 controlled separately (default) Reset: 0 <sub>B</sub>
OUT4_DD	3	rw	OUT4 direct drive mode  1 <sub>D</sub> ENABLED, OUT4 controlled by IN4 (default)  0 <sub>D</sub> DISABLED, OUT4 controlled by SPI (CTRL.OUT4_ON)  Reset: 1 <sub>B</sub>
OUT3_DD	2	rw	OUT3 direct drive mode  1 <sub>D</sub> ENABLED, OUT3 controlled by IN3 (default)  0 <sub>D</sub> DISABLED, OUT3 controlled by SPI (CTRL.OUT3_ON)  Reset: 1 <sub>B</sub>
OUT2_DD	1	rw	OUT2 direct drive mode  1 <sub>D</sub> ENABLED, OUT2 controlled by IN2 (default)  0 <sub>D</sub> DISABLED, OUT2 controlled by SPI (CTRL.OUT2_ON)  Reset: 1 <sub>B</sub>
OUT1_DD	0	rw	OUT1 direct drive mode  1 <sub>D</sub> ENABLED, OUT1 controlled by IN1 (default)  0 <sub>D</sub> DISABLED, OUT1 controlled by SPI (CTRL.OUT1_ON)  Reset: 1 <sub>B</sub>

## **Smart Quad Channel Powertrain Switch**



### 16 bit SPI interface

## Off-state diagnostic configuration register

OFF_DIAG_CFG	Offset	Reset Value
Off-state diagnostic configuration register	02 <sub>H</sub>	1F <sub>H</sub>



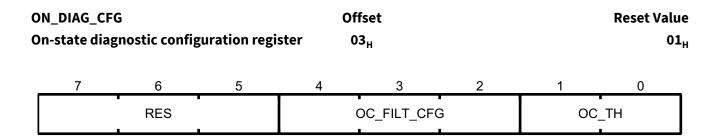
Field	Bits	Type	Description			
DIAG_FILT_CFG	5:4	rw	Diagnostic filter time configuration			
			3 <sub>D</sub> <b>2000_us</b> , 2000 us			
			2 <sub>D</sub> <b>1000_us</b> , 1000 us			
			1 <sub>D</sub> <b>500_us</b> , 500 us (default)			
			0 <sub>D</sub> <b>200_us</b> , 200 us			
			Reset: 01 <sub>B</sub>			
OUT4_DIAG_EN	3	rw	Enable diagnostic current OUT4			
			1 <sub>D</sub> <b>ON</b> , Diagnostic current ON (default)			
			0 <sub>D</sub> <b>OFF</b> , Diagnostic current OFF			
			Reset: 1 <sub>B</sub>			
OUT3_DIAG_EN	2	rw	Enable diagnostic current OUT3			
			1 <sub>D</sub> <b>ON</b> , Diagnostic current ON (default)			
			0 <sub>D</sub> <b>OFF</b> , Diagnostic current OFF			
			Reset: 1 <sub>B</sub>			
OUT2_DIAG_EN	1	rw	Enable diagnostic current OUT2			
			1 <sub>D</sub> <b>ON</b> , Diagnostic current ON (default)			
			0 <sub>D</sub> <b>OFF</b> , Diagnostic current OFF			
			Reset: 1 <sub>B</sub>			
OUT1_DIAG_EN	0	rw	Enable diagnostic current OUT1			
			1 <sub>D</sub> <b>ON</b> , Diagnostic current ON (default)			
			0 <sub>D</sub> <b>OFF</b> , Diagnostic current OFF			
			Reset: 1 <sub>B</sub>			

## **Smart Quad Channel Powertrain Switch**



### 16 bit SPI interface

## On-state diagnostic configuration register



Field	Bits	Туре	Description		
OC_FILT_CFG	4:2	rw	Overcurrent shut-down delay time (for all channels)		
			7 <sub>D</sub> <b>30_ms</b> , 30 ms		
			6 <sub>D</sub> <b>20_ms</b> , 20 ms		
			5 <sub>D</sub> <b>10_ms</b> , 10 ms		
			4 <sub>D</sub> <b>5_ms</b> , 5 ms		
			3 <sub>D</sub> <b>1_ms</b> , 1 ms		
			2 <sub>D</sub> <b>500_us</b> , 500 us		
			1 <sub>D</sub> <b>120_us</b> , 120 us		
			0 <sub>D</sub> <b>60_us</b> , 60 us (default)		
			Reset: 000 <sub>B</sub>		
ос_тн	1:0	rw	Overcurrent shut-down threshold (for all channels) (d_oc_th)		
			3 <sub>D</sub> <b>4000_mA</b> , 4 A		
			2 <sub>D</sub> <b>3000_mA</b> , 3		
			1 <sub>D</sub> <b>2000_mA</b> , 2 A (default)		
			0 <sub>D</sub> <b>1000_mA</b> , 1 A		
			Reset: 01 <sub>B</sub>		

## **Smart Quad Channel Powertrain Switch**



#### 16 bit SPI interface

## On-state diagnostic result register OUT1 & OUT2

DIAG\_OUT\_1\_2\_ON Offset Reset Value On-state diagnostic result register OUT1 &  $04_{\rm H}$  00 $_{\rm H}$  OUT2

7	6	5	4	3	2	1	0
OUT2_ST AT	OUT1_ST AT	[	DIAG_CH2_ON	I	D	IAG_CH1_O	N

Field	Bits	Туре	Description
OUT2_STAT	7	r	Channel 2 output status  1 <sub>D</sub> ON, Channel is ON  0 <sub>D</sub> OFF, Channel is OFF  Reset: 0 <sub>B</sub>
OUT1_STAT	6	r	Channel 1 output status  1 <sub>D</sub> ON, Channel is ON  0 <sub>D</sub> OFF, Channel is OFF  Reset: 0 <sub>B</sub>
DIAG_CH2_ON	5:3	rwc	On-state diagnostic result register - Channel 2  7 <sub>D</sub> UNUSED, unused combination  6 <sub>D</sub> UNUSED, unused combination  5 <sub>D</sub> OT, Overtemperature  4 <sub>D</sub> OC_TIME, Overcurrent timeout  3 <sub>D</sub> OC_OT, Overtemperature during overcurrent  2 <sub>D</sub> SCB, Short to battery  1 <sub>D</sub> NO_FAIL, no failure detected  0 <sub>D</sub> UNKNOWN, no diagnosis done  Reset: 000 <sub>B</sub>
DIAG_CH1_ON	2:0	rwc	On-state diagnostic result register - Channel 1  7 <sub>D</sub> UNUSED, unused combination  6 <sub>D</sub> UNUSED, unused combination  5 <sub>D</sub> OT, Overtemperature  4 <sub>D</sub> OC_TIME, Overcurrent timeout  3 <sub>D</sub> OC_OT, Overtemperature during overcurrent  2 <sub>D</sub> SCB, Short to battery  1 <sub>D</sub> NO_FAIL, no failure detected  0 <sub>D</sub> UNKNOWN, no diagnosis done  Reset: 000 <sub>B</sub>

## **Smart Quad Channel Powertrain Switch**



#### 16 bit SPI interface

## On-state diagnostic result register OUT3 & OUT4

DIAG\_OUT\_3\_4\_ON Offset Reset Value On-state diagnostic result register OUT3 &  $05_{\rm H}$  00 $_{\rm H}$  OUT4

7	6	5	4	3	2	1	0
OUT4_ST AT	OUT3_ST AT	[	DIAG_CH4_ON	I	D	IAG_CH3_O	N

Field	Bits	Туре	Description
OUT4_STAT	7	r	Channel 4 output status  1 <sub>D</sub> ON, Channel is ON  0 <sub>D</sub> OFF, Channel is OFF  Reset: 0 <sub>B</sub>
OUT3_STAT	6	r	Channel 3 output status  1 <sub>D</sub> ON, Channel is ON  0 <sub>D</sub> OFF, Channel is OFF  Reset: 0 <sub>B</sub>
DIAG_CH4_ON	5:3	rwc	On-state diagnostic result register - Channel 4  7 <sub>D</sub> UNUSED, unused combination  6 <sub>D</sub> UNUSED, unused combination  5 <sub>D</sub> OT, Overtemperature  4 <sub>D</sub> OC_TIME, Overcurrent timeout  3 <sub>D</sub> OC_OT, Overtemperature during overcurrent  2 <sub>D</sub> SCB, Short to battery  1 <sub>D</sub> NO_FAIL, no failure detected  0 <sub>D</sub> UNKNOWN, no diagnosis done  Reset: 000 <sub>B</sub>
DIAG_CH3_ON	2:0	rwc	On-state diagnostic result register - Channel 3  7 <sub>D</sub> UNUSED, unused combination 6 <sub>D</sub> UNUSED, unused combination 5 <sub>D</sub> OT, Overtemperature 4 <sub>D</sub> OC_TIME, Overcurrent timeout 3 <sub>D</sub> OC_OT, Overtemperature during overcurrent 2 <sub>D</sub> SCB, Short to battery 1 <sub>D</sub> NO_FAIL, no failure detected 0 <sub>D</sub> UNKNOWN, no diagnosis done Reset: 000 <sub>B</sub>

## **Smart Quad Channel Powertrain Switch**



### 16 bit SPI interface

## Off-state diagnostic result register

DIAG_OFF Off-state diagnostic result register			tregister		fset 16 <sub>H</sub>			Reset Valu	ue 0 <sub>H</sub>
	7	6	5	4	3	2	1	0	_
	DIAG_CI	H4_OFF	DIAG_C	H3_OFF	DIAG_C	CH2_OFF	DIAG_C	H1_OFF	]

Field	Bits	Туре	Description
DIAG_CH4_OFF	7:6	rwc	OFF-state diagnostic result register Channel 4  3 <sub>D</sub> SCG, Short to ground  2 <sub>D</sub> OL, Open load  1 <sub>D</sub> NO_FAIL, no failure detected  0 <sub>D</sub> UNKNOWN, no diagnosis done  Reset: 00 <sub>B</sub>
DIAG_CH3_OFF	5:4	rwc	Off-state diagnostic result register Channel 3  3 <sub>D</sub> SCG, Short to ground  2 <sub>D</sub> OL, Open load  1 <sub>D</sub> NO_FAIL, no failure detected  0 <sub>D</sub> UNKNOWN, no diagnosis done  Reset: 00 <sub>B</sub>
DIAG_CH2_OFF	3:2	rwc	Off-state diagnostic result register Channel 2  3 <sub>D</sub> SCG, Short to ground  2 <sub>D</sub> OL, Open load  1 <sub>D</sub> NO_FAIL, no failure detected  0 <sub>D</sub> UNKNOWN, no diagnosis done  Reset: 00 <sub>B</sub>
DIAG_CH1_OFF	1:0	rwc	Off-state diagnostic result register Channel 1  3 <sub>D</sub> SCG, Short to ground  2 <sub>D</sub> OL, Open load  1 <sub>D</sub> NO_FAIL, no failure detected  0 <sub>D</sub> UNKNOWN, no diagnosis done  Reset: 00 <sub>B</sub>

## **Smart Quad Channel Powertrain Switch**



### 16 bit SPI interface

## Global device status register

GLOBAL_STATUS	Offset	Reset Value		
Global device status register	07 <sub>H</sub>	01 <sub>H</sub>		

7	6	5	4	3	2	1	0
OUT_EN	SPARE	GEN_FAU LT	COM_ERR	PAR_ERR	CWD_TO	EN_LATC H	POR_LAT CH
	rw/						

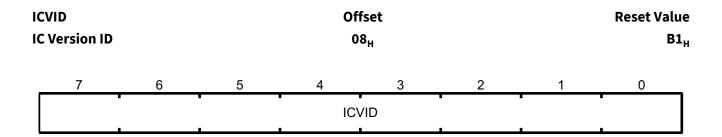
Field	Bits	Туре	Description		
OUT_EN	7	rw	OUTx enable bit $1_D$ ENABLED, Output switching enabled $0_D$ DISABLED, Outputs disabled (default) Reset: $0_B$		
SPARE	6	rw	Spare register for future use  1 <sub>D</sub> GLOBAL_STATUS_SPARE_EN,  0 <sub>D</sub> GLOBAL_STATUS_SPARE_DIS, (default)  Reset: 0 <sub>B</sub>		
GEN_FAULT	5	rwc	General fault flag  1 <sub>D</sub> ERR, At least one fault was detected  0 <sub>D</sub> NO_ERR, No fault was detected  Reset: 0 <sub>B</sub>		
COM_ERR	4	rwc	Communication Error Flag  1 <sub>D</sub> ERR, At least one communication failure was detected 0 <sub>D</sub> NO_ERR, No communication failure was detected Reset: 0 <sub>B</sub>		
PAR_ERR	3	rwc	Parity Error Flag  1 <sub>D</sub> ERR, At least one parity error was detected  0 <sub>D</sub> NO_ERR, No parity error was detected  Reset: 0 <sub>B</sub>		
CWD_TO	2	rwc			
EN_LATCH	1	rwc	EN Latch  1 <sub>D</sub> EN, Device was enabled since last read-out  0 <sub>D</sub> NO_EN, Device was not enabled since last cleared  Reset: 0 <sub>B</sub>		
POR_LATCH	0	rwc	Power-on reset latch $1_{\rm D}$ POR, Device was reset since last cleared $0_{\rm D}$ NO_POR, Device was not reset since last cleared Reset: $1_{\rm B}$		

## **Smart Quad Channel Powertrain Switch**



### 16 bit SPI interface

### **IC Version ID**

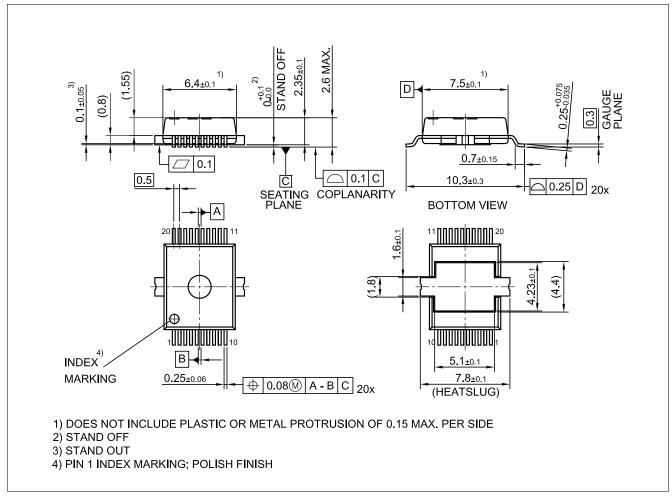


Field	Bits	Туре	Description
ICVID	7:0	r	IC Version ID 177 <sub>D</sub> ICVID, Reset: B1 <sub>H</sub>



#### **Package outlines**

## 7 Package outlines



**Figure 7-1 PG-DSO-20-88** (Plastic Dual Small Outline Package) Green Product - Package dimensions are preliminary and may be updated

#### **Green product (RoHS-compliant)**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

### Floating exposed pad

The exposed pad of TLE9104SH is not connected to the ground internally. It is highly recommended to connect the exposed pad to GND pins externally.



**Application information** 

# **8** Application information

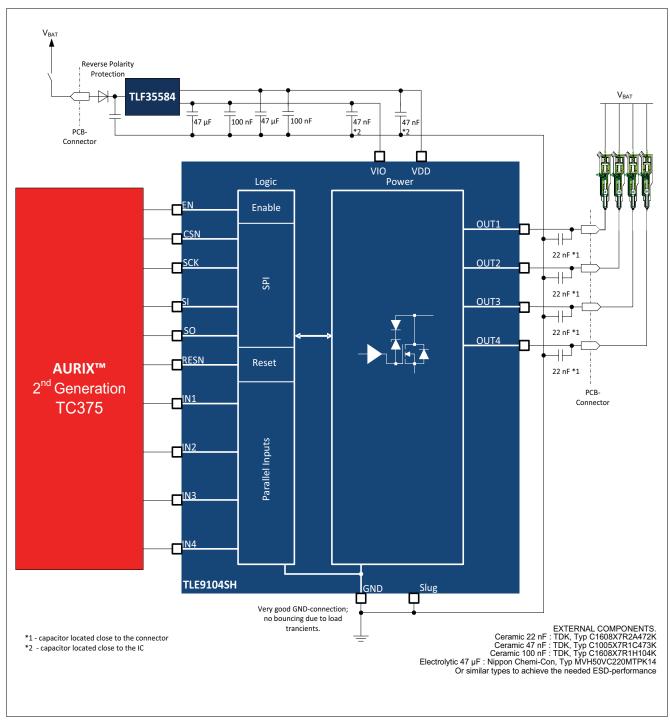


Figure 8-1 Multi port injection application diagram

## **Smart Quad Channel Powertrain Switch**



**Revision history** 

# 9 Revision history

Table 9-1 Revision history

Version	Date	Changes
Rev. 1.31	2020-09-30	Update of Output current per channel max. rating to 5.6 A (P_4.1.5)
Rev. 1.3	2020-06-05	Max. value of Short circuit to battery detection current modified
Rev. 1.2	2018-10-26	Changed H level output voltage of SO Pin symbol and minimum value changed
Rev. 1.1	2018-02-15	OC filter times updates in SPI table
Rev. 1.0	2018-02-01	First datasheet release

#### Trademarks

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